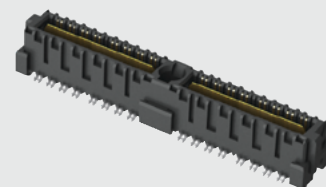


QMS-026-06.75-L-D-A



(0.635 mm) .025"

QMS SERIES

RUGGED GROUND PLANE HEADER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?QMS

Insulator Material:

Liquid Crystal Polymer

Terminal & Ground

Plane Material:

Phosphor Bronze

Plating:

Au over 50 μ" (1.27 μm) Ni

(Tin on Ground Plane Tail)

Current Rating:

Contact:

2.6 A per pin

(2 pins powered)

Ground Plane:

15.7 A per ground plane

(1 ground plane powered)

Operating Temp:

-55 °C to +125 °C

Voltage Rating:

300 VAC mated with QFS

RoHS Compliant:

Yes

Board Mates:

QFS

Cable Mates:

6QCQD

Standoffs:

SO, JSOM

ALSO AVAILABLE

(MOQ Required)

- Other platings
- Guide Posts
- Without PCB Alignment Pins (05.75 and 06.75 only)
- Hot Pluggable
- 64 (-DP) and 104 positions per row

HIGH-SPEED CHANNEL PERFORMANCE

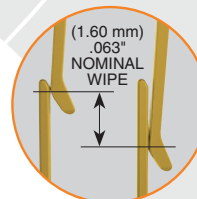
QMS-DP/QFS-DP @ 10 mm Mated Stack Height

Rating based on Samtec reference channel. For full SI performance data visit Samtec.com or contact SIG@samtec.com

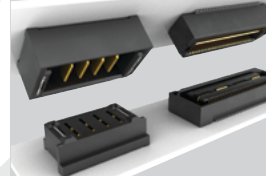
25
Gbps

Integral metal plane for power or ground

Increased insertion depth for rugged applications



POWER/SIGNAL APPLICATION



Compatible with UMP/T/UMPS for flexible two-piece power/signal solutions

PROCESSING

Lead-Free Solderable:

Yes

SMT Lead Coplanarity:

(0.10 mm) .004" max (026-052)

(0.15 mm) .006" max (078)*

*(.004" stencil solution may be available; contact IPG@samtec.com)

Board Stacking:

For applications requiring more than two connectors per board, contact ipg@samtec.com

RECOGNITIONS

For complete scope of recognitions see

www.samtec.com/quality



STANDARDS

- SUMIT™
- PCI/104-Express™
- PCI/104-Express™ OneBank

Visit www.samtec.com/standards for more information.

Note:
Some lengths, styles and options are non-standard, non-returnable.

QMS — **PINS PER ROW NO. OF PAIRS** — **LEAD STYLE** — **PLATING OPTION** — **TYPE** — **A** — **OTHER OPTION**

-026, -052, -078
(52 total pins per bank = -D)

-016, -032, -048
(16 pairs per bank = -D-DP)

(-078 & -048 Not available with -09.75 lead style)

Specify LEAD STYLE from chart

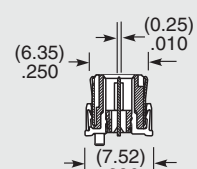
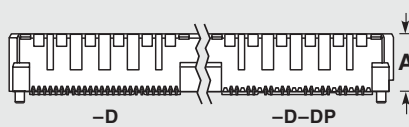
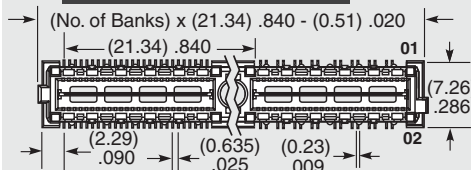
-L
(-05.75 and -06.75 lead style only)
= 10 μ" (0.25 μm) Gold on Signal Pins and Ground Plane (Tin on Signal Pin tails, and Ground Plane tails)

-SL
(-09.75 lead style only)
= 10 μ" (0.25 μm) Gold on Signal Pins and Ground Plane (Tin on Signal Pin tails, and Ground Plane tails)

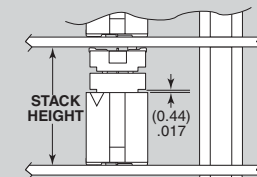
-D
= Single-Ended

-D-DP
= Differential Pair

-K
= (5.50 mm) .217" DIA Polyimide film Pick & Place Pad



APPLICATION



Requires Standoff SO-1524-03-01-01-L or JSOM-1524-02 for 15.24 mm or SO-2215-02-01-01-L for 22 mm board spacing. Connectors designed to not fully seat when mated.

LEAD STYLE	A	MATED HEIGHT*	
		QFS LEAD STYLE	-04.25
-05.75	(5.38) .212	10 mm	12 mm
-06.75	(6.35) .250	11 mm	13 mm
-09.75	(9.35) .368	14 mm	16 mm

*Processing conditions will affect mated height. See SO Series for board space tolerances.

INDUSTRY STANDARD	INTERCONNECTS			
	TERMINAL	SOCKET	BANKS	STACK HEIGHT
SUMIT™	ASP-129637-01	ASP-129646-01	1	15.24 mm
PCI/104-Express™	ASP-129637-03	ASP-129646-03	3	15.24 mm
PCI/104-Express™	ASP-129637-13	ASP-129646-22	1	15.24 mm
PCI/104-Express™	ASP-142781-01	ASP-129646-01	1	22 mm
PCI/104-Express™	ASP-142781-02	ASP-129646-02	2	22 mm
PCI/104-Express™	ASP-142781-03	ASP-129646-03	3	22 mm

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Click to view products by [Samtec](#) manufacturer:

Other Similar products are found below :

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